Surface Mount Standard Recovery Power Rectifier

SMA Power Surface Mount Package

Features construction with glass passivation. Ideally suited for surface mounted automotive applications.

Features

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Stable, High Temperature, Glass Passivated Junction
- NRVA Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant*

Mechanical Characteristics

- Case: Molded Epoxy Epoxy meets UL 94 V-0 @ 0.125 in
- Weight: 70 mg (Approximately)
- Finish: All External Surfaces are Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 seconds in Solder Bath
- Polarity: Band in Plastic Body Indicates Cathode Lead
- Marking: MRA4003T3G = R13

MRA4004T3G = R14

MRA4005T1G = R15

MRA4005T3G = R15

MRA4006T3G = R16

MRA4000T3G = R10MRA4007T3G = R17

NRVA4003T3G = R13

NRVA4004T3G = R14

NRVA4005T3G = R15

NRVA4006T3G = R16

NRVA4007T3G = R17

- ESD Rating:
 - Human Body Model 3A
 - Machine Model C



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STANDARD RECOVERY RECTIFIERS 1.0 AMPERES 300-1000 VOLTS



CASE 403D SMA

MARKING DIAGRAM



R1x = Specific Device Code

F = Wafer Source

A = Assembly Location

Y = Year

WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the ordering information section on page 4 of this data sheet.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS

		Value					
Rating	Symbol	MRA4003	MRA4004/ NRVA4004	MRA4005/ NRVA4005	MRA4006/ NRVA4006	MRA4007/ NRVA4007	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	300	400	600	800	1000	Volts
Avg. Rectified Forward Current (At Rated V _R , T _L = 150°C)	I _O	1			Amp		
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz, $T_L = 150$ °C)	I _{FRM}	2				Amps	
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I _{FSM}	30				Amps	
Junction Operating Temperature Range	TJ	-55 to 150				°C	
Storage Temperature Range	T _{stg}	-55 to 175				°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction–to–Lead (Note 1) Thermal Resistance, Junction–to–Ambient (Note 2)	$R_{ hetaJL}$ $R_{ hetaJA}$	16.2 88.3	°C/W

ELECTRICAL CHARACTERISTICS

		Value		
Characteristic	Symbol	T _J = 25°C	T _J = 100°C	Unit
Maximum Instantaneous Forward Voltage (Note 3) $(I_F = 1 \text{ A})$ $(I_F = 2 \text{ A})$	V _F	1.1 1.18	1.04 1.12	Volts
Maximum Instantaneous Reverse Current (at rated DC voltage)	I _R	10	50	μΑ

- 1. Minimum Pad Size
- 2. 1 inch Pad Size
- 3. Pulse Test: Pulse Width \leq 250 μ s, Duty Cycle \leq 2%.

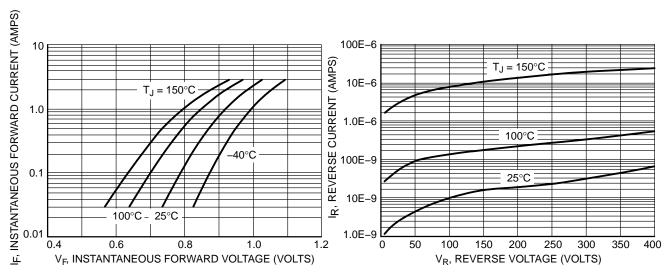
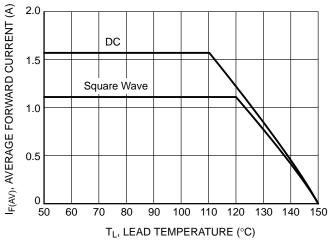


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

1.8

1.6



P_{FO}, AVERAGE POWER DISSIPATION (WATTS) 1.4 Square Wave 1.2 1.0 0.8 0.6 0.4 0.2 0 2.0 0.5 1.0 1.5 0 I_O, AVERAGE FORWARD CURRENT (AMPS)

dc

Figure 3. Current Derating

Figure 4. Forward Power Dissipation per Leg

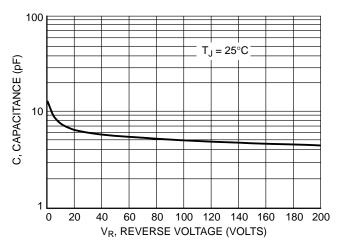


Figure 5. Capacitance

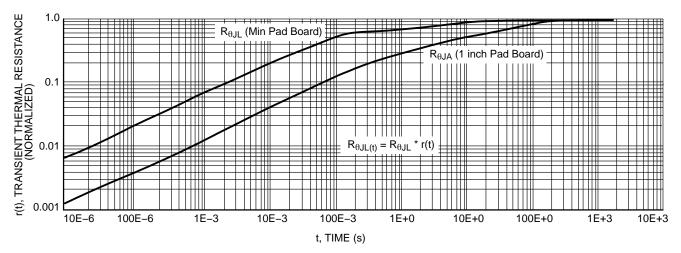


Figure 6. Thermal Response

ORDERING INFORMATION

Device	Package	Shipping†	
MRA4003T3G	SMA (Pb-Free)	F 000 / Tarra & David	
MRA4004T3G		5,000 / Tape & Reel	
MRA4005T1G		1,500 / Tape & Reel	
MRA4005T3G			
MRA4006T3G		5,000 / Tape & Reel	
MRA4007T3G			
NRVA4003T3G*			
NRVA4004T3G*			
NRVA4005T3G*		5,000 / Tape & Reel	
NRVA4006T3G*			
NRVA4007T3G*			

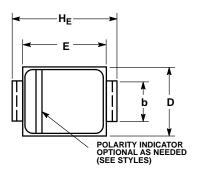
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}NRVA Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

PACKAGE DIMENSIONS

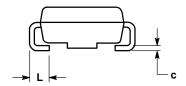
SMA

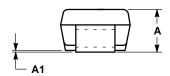
CASE 403D-02 ISSUE G



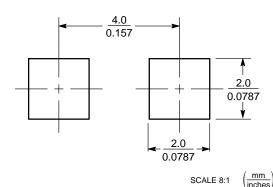
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 DIMENSION b SHALL BE MEASURED WITHIN DIMENSION L.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.97	2.10	2.20	0.078	0.083	0.087	
A1	0.05	0.10	0.20	0.002	0.004	0.008	
b	1.27	1.45	1.63	0.050	0.057	0.064	
С	0.15	0.28	0.41	0.006	0.011	0.016	
D	2.29	2.60	2.92	0.090	0.103	0.115	
E	4.06	4.32	4.57	0.160	0.170	0.180	
HE	4.83	5.21	5.59	0.190	0.205	0.220	
L	0.76	1.14	1.52	0.030	0.045	0.060	





SOLDERING FOOTPRINT*



SCALE 8:1

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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